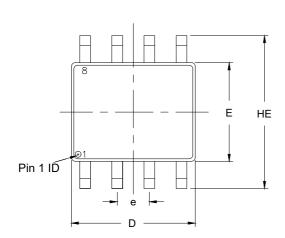
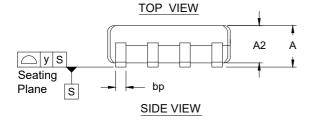
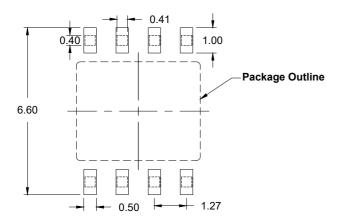
Package Outline Drawing



Package Code:DCG8D4 8-SOIC 4.9 x 3.9 x 1.75 mm Body, 1.27mm Pitch PSC-4068-04, Revision: 00, Date Created: 04/14/2022



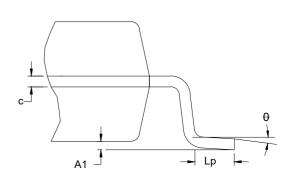




RECOMMENDED LAND PATTERN (PCB Top View, SMD Design)

NOTES:

- 1. JEDEC compatible.
- 2. All dimensions are in mm and angles are in degrees.



LEAD DETAIL

Reference	Dimension in mm	
Symbol	Min	Max
Α	1.35	1.75
D	4.80	5.00
E	3.80	4.00
A1	0.10	0.30
A2	1.32	1.55
HE	5.80	6.20
bp	0.31	0.51
С	0.10	0.25
е	1.27	
у	-	0.10
Lp	0.40	
θ	0	8

* WITHOUT MOLD FLASH